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Application Serial No. 10/768,568
 Confirmation No. 6339
 Filing Date January 29, 2004
 Inventor Jerome M. Eldridge
 Assignee Micron Technology, Inc.
 Group Art Unit 2822
 Examiner K. Duong
 Attorney's Docket No. MI22-2496
 Customer No. 021567
 Title: Perovskite-Type Material Forming Methods, Capacitor Dielectric Forming
 Methods, and Capacitor Constructions

TERMINAL DISCLAIMER

I, James E. Lake, residing at Liberty Lake, Washington, represent that I am the attorney of record for Micron Technology, Inc., a corporation of the state of Delaware. Micron Technology, Inc. is the owner of all right, title and interest of this U.S. Patent Application Serial No. 10/768,568, filed January 29, 2004, as evidenced by an assignment recorded December 3, 2001, Reel 12344, Frames 0176-0180 in the U.S. Patent and Trademark Office.

Micron Technology, Inc. is also the owner of all rights, title and interest in U.S. Patent No. 6,730,575, as evidenced by an assignment recorded December 3, 2001, at Reel 12344, Frames 0176-0180, in the U.S. Patent and Trademark Office.

The evidentiary documents have been reviewed, and I certify that, to the best of assignee's knowledge and belief, title is in the assignee seeking to take this action.

Micron Technology, Inc. hereby disclaims the terminal part of any future patent granted on this U.S. Patent Application Serial No. 10/768,568 which extends beyond the expiration date of U.S. Patent No. 6,730,575, and further hereby agrees that any future patent so granted on this U.S. Patent Application Serial No. 10/768,568 shall be enforceable only for and during such period that the legal title on the U.S. Patent No. 6,730,575 shall be the same as the legal title to any patent

issued from U.S. Patent Application Serial No. 10/768,568. This agreement is to run with any patent granted on the application and is to be binding upon the grantee of such patent and its successors or assigns.

Micron Technology, Inc. does not disclaim any terminal part of any patent granted on this 10/768,568 application prior to the expiration date of the full statutory term of the United States Patent No. 6,730,575 in the event that it later: expires for failure to pay a maintenance fee, is held unenforceable, is found invalid by a court of competent jurisdiction, is statutorily disclaimed in whole or terminally disclaimed under 37 C.F.R. §1.321(a), has all claims canceled by a reexamination certificate, is reissued in any manner or is otherwise terminated prior to expiration of its full statutory term as presently shortened by any terminal disclaimer, except for the separation of legal title stated above.

The fee required by 37 C.F.R. 1.20(d) is submitted herewith. The Commissioner is hereby authorized to charge payment of any additional fees or credit overpayments to Deposit Account No. 23-0925.

The undersigned, James E. Lake, hereby indicates that he is authorized to sign this document on behalf of the assignee, Micron Technology, Inc.

Respectfully submitted,

Dated: 10 Jan 2005

By: 

James E. Lake

Reg. No. 44,854